

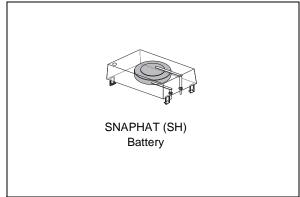
# M4Z28-BR00SH M4Z32-BR00SH

# ZEROPOWER® SNAPHAT® (BATTERY)

#### **FEATURES SUMMARY**

- PROVIDES BATTERY BACKUP POWER FOR NON-VOLATILE ZEROPOWER and SUPERVISOR DEVICES IN THE 28-PIN SNAPHAT SOIC PACKAGE
- REMOVABLE BATTERY AVOIDS HEAT ASSOCIATED WITH SURFACE-MOUNT PROCESS
- SNAPS DIRECTLY ONTO SURFACE-MOUNTED SNAPHAT SOIC
- CHOICE OF BATTERY CAPACITIES
  - M4Z28-BR00SH = 48mAh
  - M4Z32-BR00SH = 120mAh
- KEYED INSERTION TO INSURE PROPER ASSEMBLY
- REMOVABLE FOR REPLACEMENT and PROPER DISPOSAL
- Pb-FREE PACKAGE
- AVAILABLE IN TUBES OR TAPE & REEL

Figure 1. SNAPHAT Top Package



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# M4Z28-BR00SH, M4Z32-BR00SH

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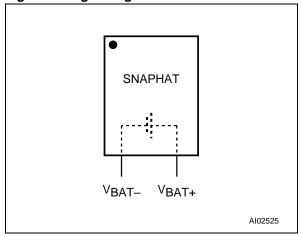
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#### SUMMARY DESCRIPTION

The M4ZXX-BR00SH SNAPHAT® top is a detachable lithium power source for ST's non-volatile ZEROPOWER® surface-mount SOIC (MH) package (28-pin).

The SNAPHAT top contains a lithium battery and is designed to be "snapped on" after the SOIC is surface mounted on the PC board. The two-piece solution prevents the battery from being exposed to the high temperatures of the surface mount process.

Figure 2. Logic Diagram



**Table 1. Signal Names** 

V <sub>BAT</sub> _	Negative Voltage	
V <sub>BAT+</sub>	Positive Voltage	

#### **MAXIMUM RATING**

Stressing the device above the rating listed in the "Absolute Maximum Ratings" table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is

not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

**Table 2. Absolute Maximum Ratings** 

Symbol	Parameter	Value	Unit
T <sub>A</sub>	Ambient Operating Temperature	-40 to 85	°C
T <sub>STG</sub>	Storage Temperature (V <sub>CC</sub> Off, Oscillator Off)	-40 to 85	°C

CAUTION: Do NOT wave solder SOIC to avoid damaging SNAPHAT sockets.

#### DC AND AC PARAMETERS

This section summarizes the operating and measurement conditions, as well as the DC and AC characteristics of the device. The parameters in the following DC and AC Characteristic tables are derived from tests performed under the Measure-

ment Conditions listed in the relevant tables. Designers should check that the operating conditions in their projects match the measurement conditions when using the quoted parameters.

**Table 3. Operating and AC Measurement Conditions** 

Parameter	M4Z28-BR00SH	M4Z32-BR00SH	Unit
Nominal Battery Voltage (V <sub>CC</sub> )	2.8	2.8	V
Nominal Battery Capacity	48	120	mAh
Battery Chemistry	Li(CF)	Li(CF)	

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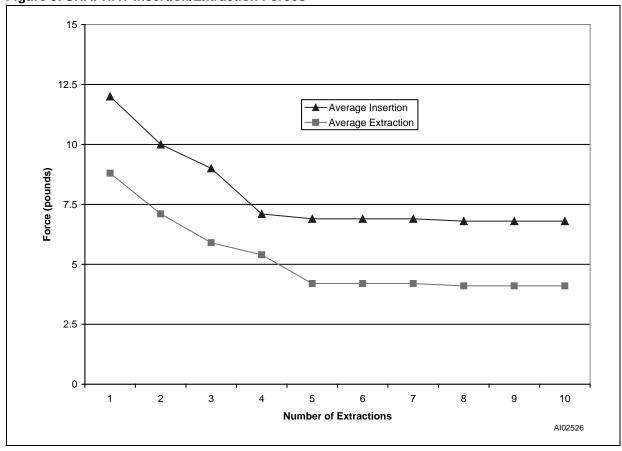
#### **MECHANICAL INFORMATION**

Electrical connection to the SOIC is made through two pins that connect to the press fitted sockets at one end of the SOIC. Critical contact points between the pins and sockets are gold-plated to resist oxidation. Internally, each socket contains six independent contact fingers to form redundant connections between the two components. These sockets were designed to provide high point contact force to provide the lowest possible contact resistance. The SNAPHAT® top also incorporates four molded-in retaining clips which hold onto the ends of the SOIC insuring mechanical and electrical connection even under severe mechanical shock and vibration. The combined SOIC and SNAPHAT assembly can sustain shock levels in

excess of 100 g without separating. This package also passes variable frequency testing in accordance with MIL-STD-883, method 2007.2, condition A.

Figure 3 illustrates the affect of repeated insertion and extraction of the SNAPHAT top to the SOIC. The force required to extract the SNAPHAT, and then to re-insert it, reduces each time. After four or five extractions, the reduction starts to become unnoticeable and the force required remains at a fairly constant figure. Typically, though, the SNAPHAT will only need to be extracted and reinserted once in its lifetime.

Figure 3. SNAPHAT Insertion/Extraction Forces



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#### **Battery Characteristics**

Figure 4, page 7 illustrates the lithium coin cell discharge rate for a given load. This demonstrates the characteristically flat voltage level supplied by the battery until very near the end of its life. These discharge levels have been greatly accelerated in comparison to the normal, actual usage.

**Note:** These batteries contain no Mercury (Hg), Cadmium (Cd), or Lead (Pb).

### **UL Recognition**

The M4ZXX-BR00SH has been recognized by Underwriters Laboratories under their Component Recognition Program and carries U.L. File Number E89556.

#### **Battery Life**

For information on Data Retention Life and Battery Storage Life, please refer to the Application Note AN1012.

#### **General Notes**

ST has conducted experiments using a manual press which determined that if approximately 60

pounds of force is applied to the top of the SNAPHAT<sup>®</sup>, battery damage and/or die cracks could be induced. As Figure 3, page 5 specifies, only an average of less than 13 force-pounds is required for proper insertion. We recommend that no more than 40 pounds of force be applied during SNAPHAT insertion.

If a manual press in employed, it is very important that it be calibrated such that it cannot exceed this limit.

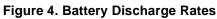
To remove the SNAPHAT® top for replacement, a DIP/IC extractor tool should be used (see Figure 5). The SNAPHAT top should be grabbed by the narrow end to avoid bending the pins.

**Caution**: To avoid draining battery do NOT place SNAPHAT pins into conductive foam.

**Caution**: To avoid damaging SNAPHAT sockets do NOT wave solder SOIC.

For battery disposal information, see on the web at **www.rayovac.com**.

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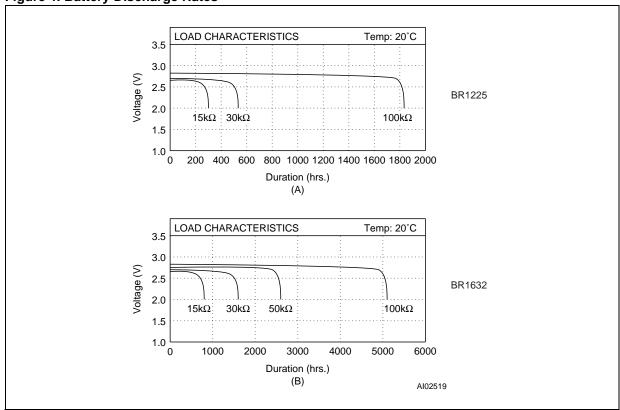
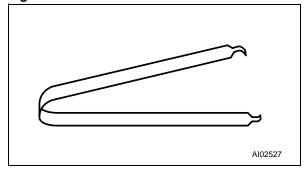
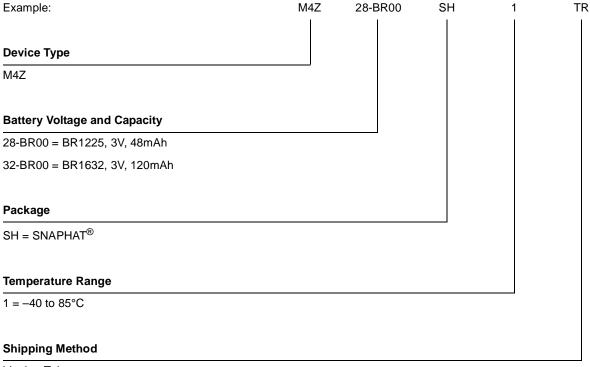


Figure 5. DIP Extractor Tool



# **PART NUMBERING**

# **Table 4. Ordering Information Scheme**



blank = Tubes

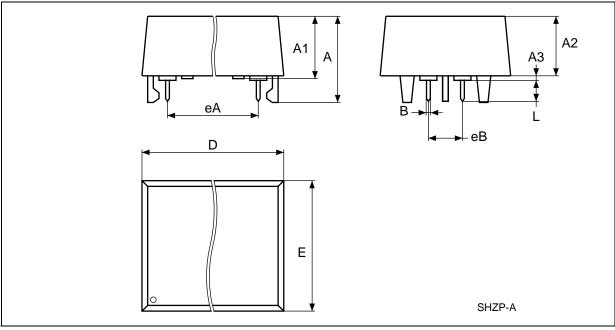
TR = Tape & Reel

For a list of available options (e.g., Speed, Package) or for further information on any aspect of this device, please contact the ST Sales Office nearest to you.

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# PACKAGE MECHANICAL INFORMATION

Figure 6. SH – 4-pin SNAPHAT Housing for 48mAh Battery Package Outline



Note: Drawing is not to scale.

Table 5. SH – 4-pin SNAPHAT Housing for 48mAh Battery Package Mechanical Data

Symb		mm		inches		
Syllib	Тур	Min	Max	Тур	Min	Max
А			9.78			0.385
A1		6.73	7.24		0.265	0.285
A2		6.48	6.99		0.255	0.275
А3			0.38			0.015
В		0.46	0.56		0.018	0.022
D		21.21	21.84		0.835	0.860
E		14.22	14.99		0.560	0.590
eA		15.55	15.95		0.612	0.628
eB		3.20	3.61		0.126	0.142
L		2.03	2.29		0.080	0.090

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Figure 7. SH – 4-pin SNAPHAT Housing for 120mAh Battery Package Outline

Note: Drawing is not to scale.

Table 6. SH - 4-pin SNAPHAT Housing for 120mAh Battery Package Mechanical Data

Symb	mm			inches		
	Тур	Min	Max	Тур	Min	Max
А			10.54			0.415
A1		8.00	8.51		0.315	0.335
A2		7.24	8.00		0.285	0.315
А3			0.38			0.015
В		0.46	0.56		0.018	0.022
D		21.21	21.84		0.835	0.860
E		17.27	18.03		0.680	0.710
eA		15.55	15.95		0.612	0.628
eB		3.20	3.61		0.126	0.142
L		2.03	2.29		0.080	0.090

# **REVISION HISTORY**

**Table 7. Document Revision History** 

Date	Rev. #	Revision Details		
November 1999	1.0	First Issue		
29-May-01	2.0	Reformatted		
04-Jun-01	2.1	Basic textual changes from reformatting activity		
10-Jul-01	2.2	Remove references to "Crystal;" change references to "SUPERVISOR" from Controller; clarify temperature characteristics		
21-Jan-02	2.3	Change to include Crystal Accuracy (Table 3); add text for SNAPHAT insertion force tolerance and battery characteristics note		
20-Aug-02	2.4	Update Insertion/Extraction Forces (Figure 3)		
14-Mar-03	2.5	Add Pb-free note on page 1		



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